



 <p>Masach Technologies Board Level Shielding Design & fabrication</p> <p>www.masach.com</p>	Item No:	Description:	Material:
	MS259-10	DRAWN RF SHIELD FRAME + COVER	TIN STEEL (See Note 1-2)
	<p>Note: (1) TS275E 8.4/8.4 (2) Electrolytic Tin Plate As Per EN 10202:2001 Min Tin Thickness 3.5 μm (3) General tolerance ± 0.2mm Non Dimensioned items remain Masach Technologies LTD property.</p>		
www.masach.com			MMGS / Print 1:1 / A4